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Note: This cover page establishes the Doc No., Title and current status of the attached document.

DOCUMENT COVER PAGE

Doc No.	SDSC-PSE-AN80T05	Issue Level	Rev	Eff Date
DUC NO.	3030-1 3E-AN80103	1	4	21-MAR-05
Doc Title	Product Specifications for AN80T05	Total no. of pag (excluding this p		11

Revision History

Issue	Rev	Eff Date	S/N	Page	Change Details	Remarks
1	3	16-DEC-04	1	-	Added this cover page.	
			2	9	Removed this page.	
			3	9A	Added this page for leadfree specification.	
			4	9A	Amended Outer Lead Surface Process &	
					Chip Mounting Method.	
	4	21-MAR-05	1	8	Removed physical product marking indications.	
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Prepared Checked	M.A.M. FOWZAN Kenneth faw	Product Specifications APREQUE AN80T05	
Approved	All	FINAL SPECS Page No.	1
S	Structure	Silicon Monolithic Bipolar IC	
	Appearance	SIL-12 Pins Plastic Package (Power Type With Fin)	
	Application	Voltage Supply for Car Audio Systems	
I	Function	7 Outputs Voltage Regulator Peak Current Protection Circuit, ASO Protection Circuit, Thermal Protection Circuit	on

A	Absolu	te Maximu	m Ratings		
No.	Item	Symbol	Ratings	Unit	Note
1	Storage Temperature	Tstg	-55 ~ +150	° C	1
2	Operating Ambient Temperature	Topr	-30 ~ +85	° C	1
3	Operating Ambient Pressure	Popr	$\frac{1.013 \times 10^{5} \pm 0.61 \times 10^{5}}{(1.0 \pm 0.6)}$	Pa (atm)	
4	Operating Constant Acceleration	Gopr	9,810 (1,000)	m / s ² (G)	
5	Operating Shock	Sopr	4,900 (500)	m / s ² (G)	
6	Power Supply Voltage	Vcc	26.0	V	
7	Power Supply Current	Icc	3.8	А	2
8	Power Dissipation	PD	2.70	W	3

Operating Supply Voltage Range

 $6.6 \text{ V} \sim 24.0 \text{ V}$

Note : 1) Except these items, all other measurements are taken at $Ta = 25^{\circ}C$.

2) Over current limiting circuit built-in.

3) Ta = 75°C without heat sink. The relationship between power dissipation and ambient temperature follows that of derating curve.

Vcc

	······································		1	
	Eff. Date	Eff. Date	Eff. Date	Eff. Date
2	23-Aug-1999	22-SEP-99	1-Jun-2000	

Prepared Checked	M.A.M. FOWZAN Kenneth Jaw	Product S	Specifi N80T		APRE XTERN	ROVEI Meades	
Approved	Algha				Pa	ge No.	2
	Recommended Oper	••••••••••••••••••••••••••••••••••••••	Iition	ECS		MECS OT.US.TO OCCUMENT CONTROL)
No.	Item	Symbol		Limit		Unit	Note
			Min	Тур	Max	-	
1	Recommended Power	Vcc	10.0	13.2	16.0	V	
	Supply Voltage		11.0	13.2	16.0	v	1

Note : 1) This range is applicable to Illumination Output which is V(Out)ILL=10V.

Eff. Date	Eff. Date	Eff. Date	Eff. Date
23-Aug-1999	22-SEP-99	1-Jun-2000	

Prepared M.A.M.FOWZAN Product Specifications

Checked Kenneth Law Approved

AN80T05

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				3.2V.)		Limit			
No.	Item	Symbol	Test Cct.	Condition	Min	Тур	Max	Unit	Not
····	<vill 1="" output=""></vill>						<u> </u>		
1	Output Voltage Vo1	Vill		I01=-240mA	9.5	10	10.5	v	
2	Line Regulation	REGIN(ILL)		V01=10V, I01=-240mA Vcc=11~16V	-	20	60	mV	
3	Load Regulation	REGL(ILL)		Vo1=10V, Io1=0~-240mA	-	60	120	mV	
4	Min. Input/Output Voltage Difference	VDIF1(min)		V01=10V, Vcc=9V I01=-240mA	-	0.4	0.7	V	
5	Peak Output Current	IO1(peak)		Vo1≥9.5V	300	550	-	mA	
6	Ripple Rejection Ratio	RR1		V01=10V, f=100Hz VCC=12~14V	40	55	-	dB	
	<vdd 2="" output=""></vdd>								
7	Output Voltage Vo2	Vdd		I02=-80mA	5.3	5.6	5.9	V	
8	Line Regulation	REGIN(VDD)		V02=5.6V, I02=-80mA VCC=10~16V		5	15	mV	
9	Load Regulation	REGL(VDD)		V02=5.6V, I02=0~-80mA	-	50	120	mV	
10	Min. Input/Output Voltage Difference	VDIF2(min)		V02=5.6V, Vcc=5V I02=-80mA	_	0.4	0.7	V	
11	Peak Output Current	IO2(peak)		Vo2≥5.3V	100	200	-	mA	
12	Ripple Rejection Ratio	RR2		V02=5.6V, f=100Hz Vcc=12~14V	50	60		dB	
	<amp 3="" output=""></amp>								
13	Min. Input/Output Voltage Difference	VDIF3(min)		I03=-400mA		1	1.5	v	
14	Load Regulation	REGL(AMP)		I03=0~-400mA	-	350	600	mV	
15	Peak Output Current	IO3(peak)		Vo3≥11.7V	500	800	-	mA	

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Checked	Kenneth Law
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			Test			Limit			
No.	Item	Symbol	Cct.	Condition	Min	Тур	Max	Unit	Note
	<ant 4="" output=""></ant>								
16	Min. Input/Output Voltage Difference	VDIF4(min)		I04=-400mA	_	1	1.5	v	
17	Load Regulation	REGL(ANT)		I04=0~-400mA	-	350	600	mV	
18	Peak Output Current	IO4(peak)		V04≥11.7V	500	800	-	mA	
	<vcoм 5="" output=""></vcoм>								
19	Output Voltage Vo5	VCOM		I05=-120mA	8.25	8.70	9.15	v	
20	Line Regulation	REGIN(COM)		V05=8.7V, I05=-120mA Vcc=10~16V	-	10	30	mV	
21	Load Regulation	REGL(COM)		V05=8.7V, I05=0~-120mA	-	60	120	mV	
22	Min. Input/Output Voltage Difference	VDIF5(min)		V05=8.7V, Vcc=7.8V I05=-120mA		0.4	0.7	V	
23	Peak Output Current	IO5(peak)		Vo5≥8.25V	150	300	-	mA	
24	Ripple Rejection Ratio	RR5		V05=8.7V, f=100Hz Vcc=12~14V	50	60		dB	
	<am 6="" output=""></am>								
25	Output Voltage Vo6	VAM		I06=-120mA	8.25	8.70	9.15	V	
26	Line Regulation	REGIN(AM)		V06=8.7V, I06=-120mA Vcc=10~16V	-	10	30	mV	
27	Load Regulation	REGL(AM)		V06=8.7V, I06=0~-120mA		60	120	mV	
28	Min. Input/Output Voltage Difference	VDIF6(min)		V06=8.7V, Vcc=7.8V I06=-120mA	-	0.4	0.7	V	
29	Peak Output Current	IO6(peak)		Vo6≥8.25V	150	300	-	mA	
30	Ripple Rejection Ratio	RR6		V06=8.7V, f=100Hz Vcc=12~14V	50	60	-	dB	

Eff. Date	Eff. Date Eff. Date	Eff. Date
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Product Specifications APROVED AN80T05

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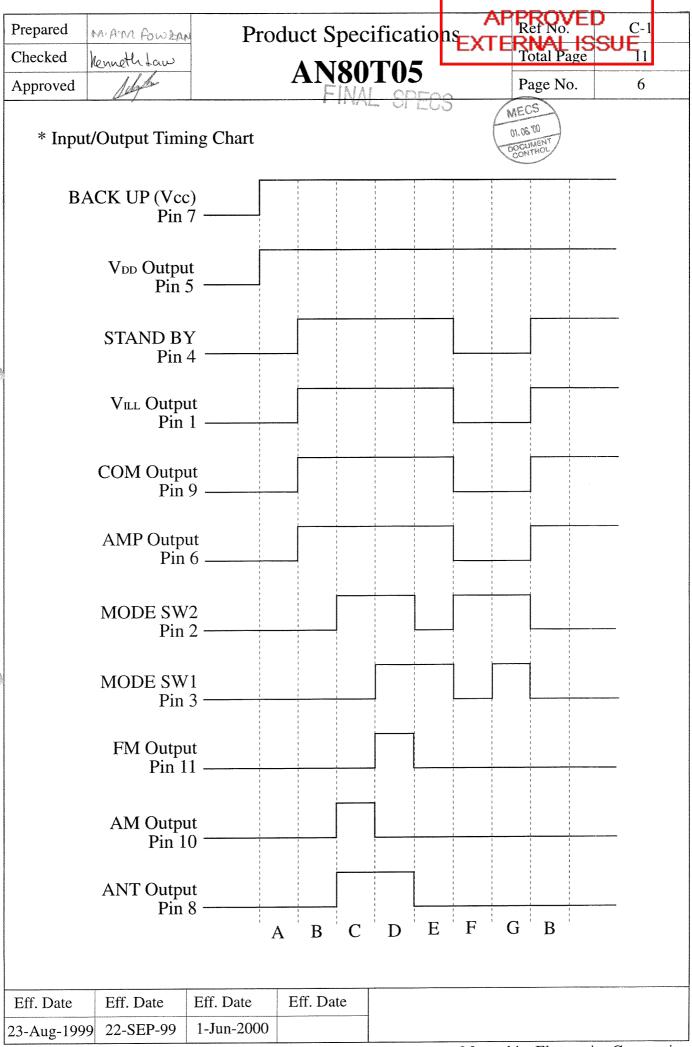
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CONTROL

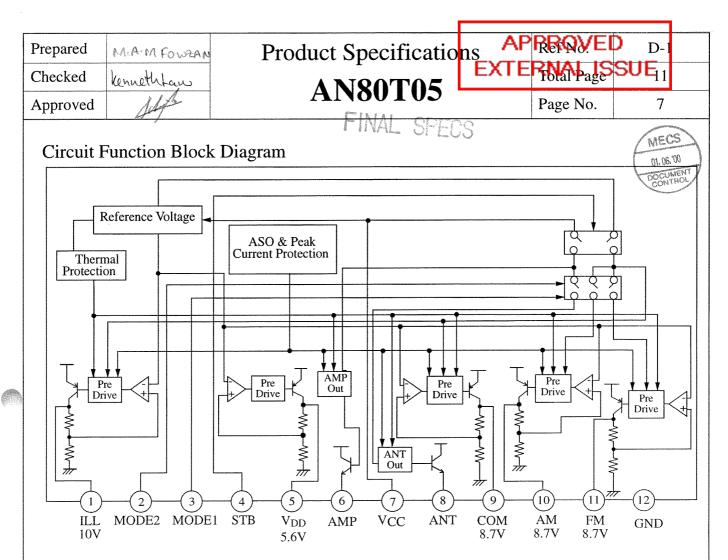
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No.	Item	Symbol	Test Cct.	3.2V.) Condition		Limit			
					Min	Тур	Max	Unit	Note
	<fm 7="" output=""></fm>								
31	Output Voltage Vo7	Vfm		I07=-200mA	8.25	8.70	9.15	v	
32	Line Regulation	REGIN(FM)		V07=8.7V, I07=-200m/ Vcc=10~16V	4	20	60	mV	
33	Load Regulation	REGL(FM)		V07=8.7V, I07=0~-200mA	-	60	120	mV	
34	Min. Input/Output Voltage Difference	VDIF7(min)		V07=8.7V, Vcc=7.8V I07=-200mA	-	0.4	0.7	V	
35	Peak Output Current	IO7(peak)		Vo7≥8.25V	250	450		mA	
36	Ripple Rejection Ratio	RR7		V07=8.7V, f=100Hz Vcc=12~14V	45	55	-	dB	
37	Standby Circuit Current	Istb		Standby Pin=0V	-	0.55	0.80	mA	
	Input (Standby)								
38	Standby Level	VTH1-1			-	-	1.1	V	
39	Active Level	VTH1-2			1.7	-	-	V	
40	Input Current when High	Iin1		Vth1=5V	100	175	250	μΑ	
	Input (Mode 2 SW)								
41	Standby Level	VTH2-1			-	-	1.6	V	
42	Active Level	Vth2-2			2.4	-	-	V	
43	Input Current when High	Iin2		Vth2=5V	13	25	37	μA	
	Input (Mode 1 SW)								
44	Voltage when AM ON	VTH3-1			-	-	1.1	V	
45	Voltage when FM ON	VTH3-2			2.7	-	-	V	
46	Input Current when High	Iin3		Vth3=5V	13	25	37	μA	



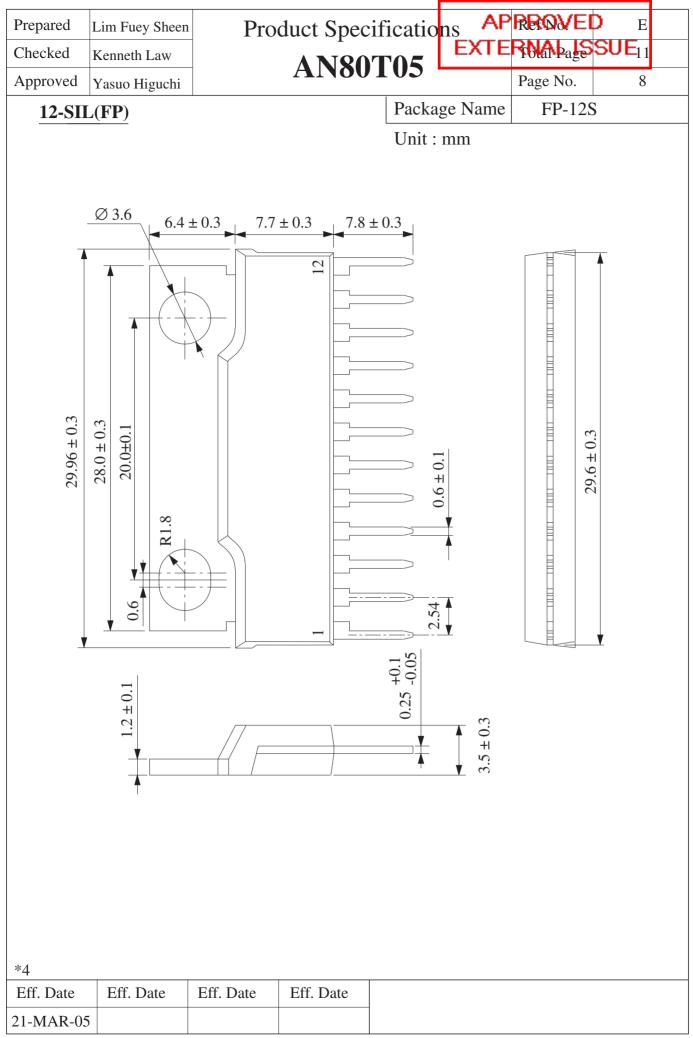
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Pin Descriptions

Pin No.	Pin Descriptions	Function				
1	Illumination Output	10V power supply with a maximum output current of 300mA for a Illuminati				
2	MODE2 SW	AM and ANT output are turned ON when this pin is 5V.				
3	MODE1 SW	AM and FM output are switched when this pin is 5V.				
4	STAND BY	Only VDD output during the 0V standby state; ILL, COM and AMP				
		outputs are turned ON when this pin is 5V.				
5	VDD Output	5.6V Power supply with a maximum output current of 100mA for a micro-				
		controller. Output is always available if BACKUP power supply is connected.				
6	AMP Output	Power supply to activate a remote amplifier; a voltage of about 1V (Typ) lower				
-		than Vcc voltage is provided with a maximum output current of 500mA.				
7	VCC	Connected to car BACKUP and ACC Power supplies.				
8	ANT Output	Output Power supply to drive an antenna voltage of about 1V (Typ) lower than the Vo				
voltage is provided wit		voltage is provided with a maximum output current of 500mA.				
9	COM Output	8.7V power supply with a maximum output current of 150mA; this can be used				
		as a system common power supply.				
10	AM Output 8.7V power supply with a maximum output current of 150mA for AM rec					
11	FM Output 8.7V power supply with a maximum output current of 250mA for FM received					
12	GND					
L	1					
Tff Data Eff Data		Eff. Data Eff. Data				

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Semiconductor Company, Matsushita Electric Industrial Co., Ltd.

Prepared	Lim Fuey Sheen	Product Specifications	S APRROVED F		
Checked	Kenneth Law	(Leadfree)	EXTERNAL	\mathbf{OE}_{11}	
Approved	Yasuo Higuchi	AN80T05	Page N	0.	9A
(Structu	re Description)			
Chip surf	ace passivation	SiN, PSG,	Others ()	1
Lead fram	ne material	Fe group, Cu group,	Others ()	2,6
Inner lead	l surface process	Ag plating, Au plating,	Others ()	2
Outer lea	d surface process	Solder plating (98Sn-2Bi), Solder dip	p, Others ()	6
Chip mou	inting method	Ag paste, Au-Si alloy, Solder (9	95.5Pb-2.5Ag-28	Sn)**	3
Wire bon	ding method	Thermalsonic bonding,	Others ()	4
Wire mat	erial	(Au,	Others ()	4
Mold ma	terial	(Epoxy,)	Others ()	5

Package	FP-12S
I achage	

Molding method

Fin material

**Under RoHS exemption clause, Lead (Pb) in high melting temperature type solder (i.e. tin-lead solder alloys containing more than 85% of lead), is exempted until 2010.

Others (

Others (

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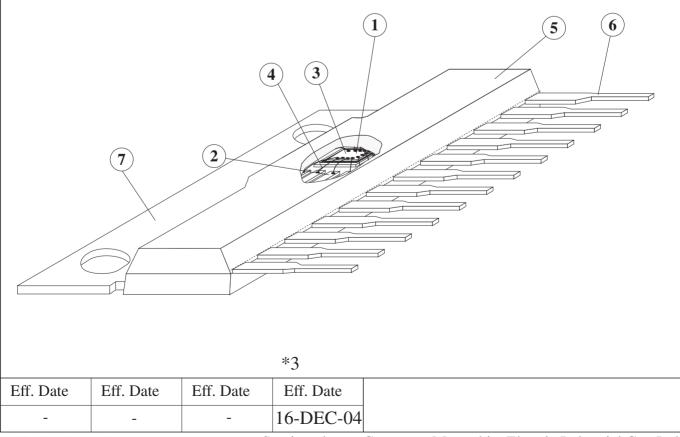
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Multiplunger mold,

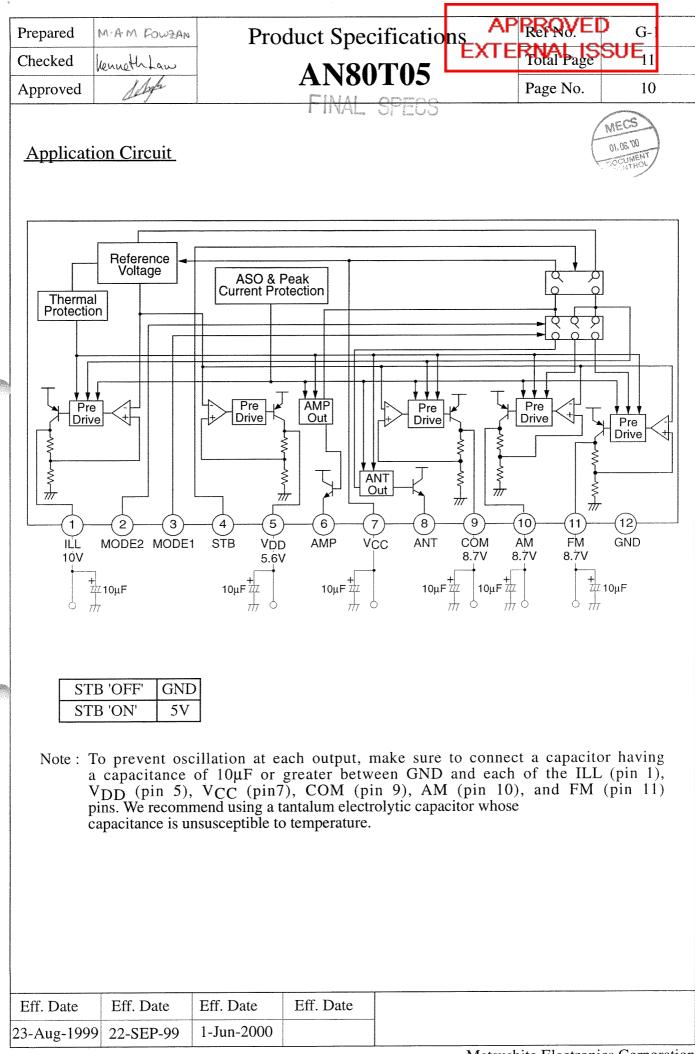
Transfer mold,

Cu group,

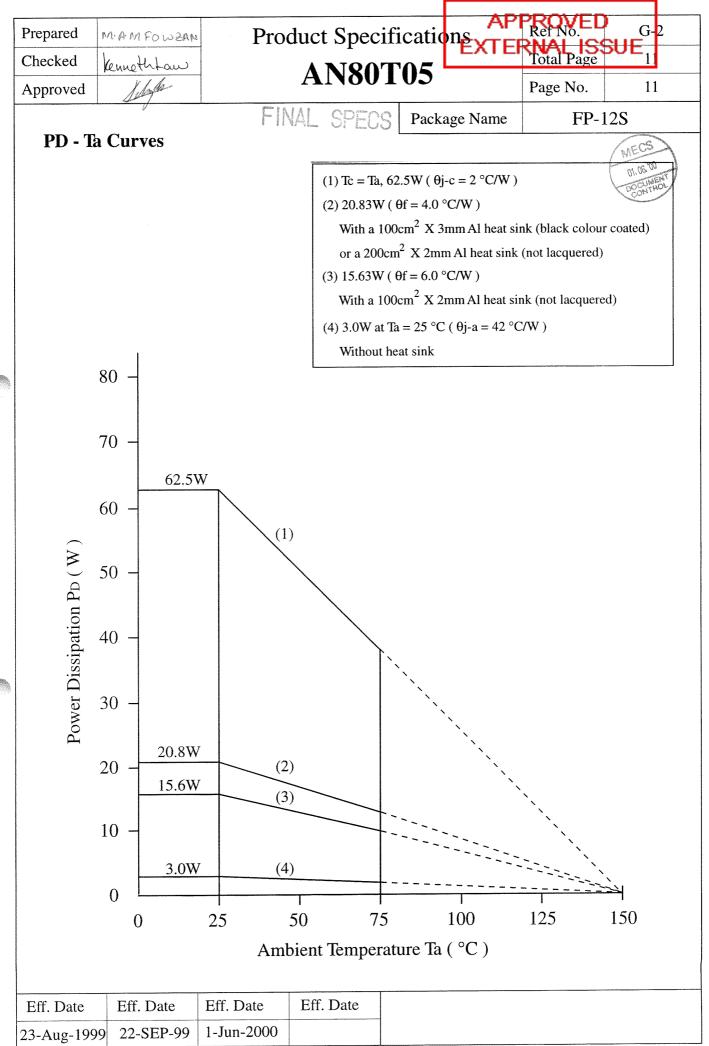


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